

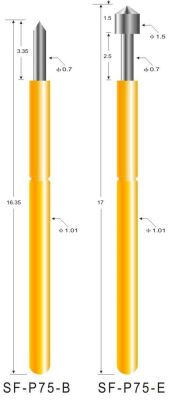
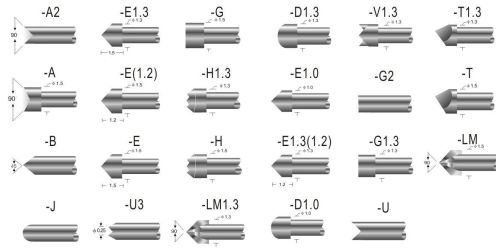
Sonda de contacto con resorte de prueba de PCB

Información del Producto

Marca	SFENG
Número de artículo	Sonda de contacto con resorte de prueba de PCB
Serie	SF-PA75, SF-PA11 y SF-PA111
Émbolo	Be Cu, oro / niquelado
Cuerpo	Latón, chapado en oro
Primavera	acero inoxidable
Fuerza de la primavera	120 g, 150g, y 120g
Current proporciónnorte	3A



SF-P75



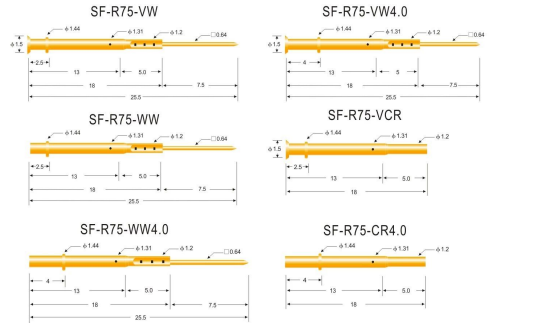
Probe specifications SF-P75(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压克力: 1.35mm(.0532") 电木板、玻璃纤维板: 1.40mm(.0551")
- Full travel(行程): 3.35(.1319")/2.50(.0984")
- Spring force(弹簧压力): 120g
- Materials and finishes(材料及涂饰): Plunger: Be Cu, Rh plated; SK4, Rh plated Barrel: Phosphor bronze, Gold plated Spring: Stainless steel
- Current rating(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50m Ω (毫欧姆)

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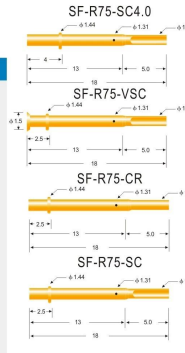
Noted: Specifications subject to change without notice(注: 规格变动不另行通知)

SF-R75



Probe specifications SF-R75(技术规格)

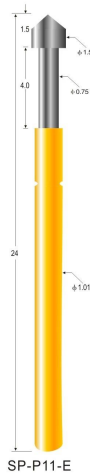
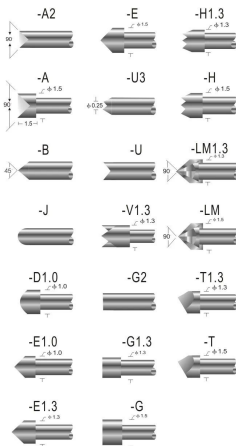
- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压克力: 1.35mm(.0532") 电木板、玻璃纤维板: 1.40mm(.0551")
- Materials and finishes(材料及涂饰): Barrel: Brass, Gold plated
- Connections(接线形式): Crimp: R75-VCR, R75-CR, R75-CR4.0 Solder cup: R75-VSC, R75-SC, R75-SC4.0 Wire wrap: R75-VW, R75-WW, R75-VW4.0, R75-WW4.0



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SF-P11



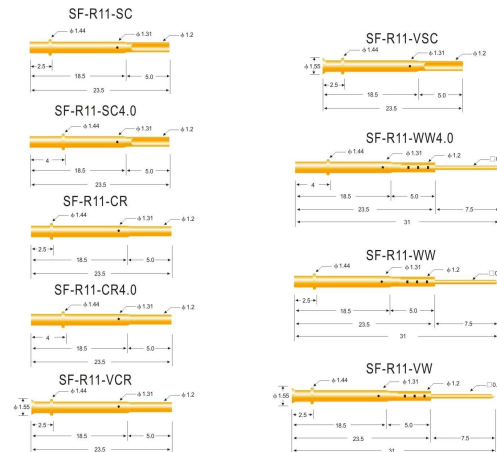
Probe specifications SF-P11(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压克力: 1.35mm(.0532") 电木板、玻璃纤维板: 1.40mm(.0551")
- Full travel(行程): 4.0(.1575")
- Spring force(弹簧压力): 150g
- Materials and finishes(材料及涂饰): Plunger: Be Cu, Rh plated Barrel: Brass, Gold plated Spring: Stainless steel
- Current rating(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50m Ω (毫欧姆)

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SF-R11



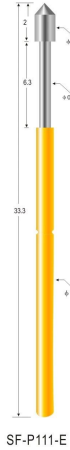
Probe specifications SF-R11(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压克力: 1.35mm(.0532") 电木板、玻璃纤维板: 1.40mm(.0551")
- Materials and finishes(材料及涂饰): Barrel: Brass, Gold plated
- Connections(接线形式): Crimp: R11-VCR, R11-CR, R11-CR4.0 Solder cup: R11-VSC, R11-SC, R11-SC4.0 Wire wrap: R11-VW, R11-WW, R11-WW4.0

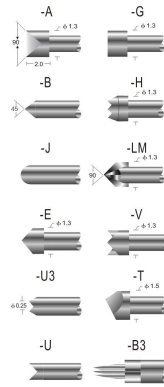
Noted: Specifications subject to change without notice(注: 规格变动不另行通知)

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SF-P111



SF-P111-E

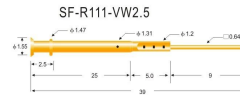
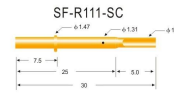
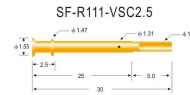
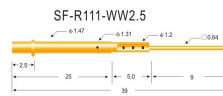
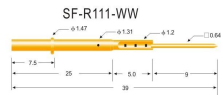
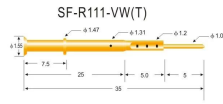
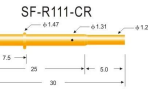
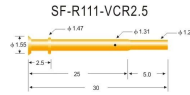


Probe specifications SF-P111(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压力: 1.35mm(.0532")
电木板、玻璃纤维板: 1.40mm(.0551")
- Full travel(行程): 6.3(.2481")
- Spring force(弹簧压力): 120g
- Materials and finishes(材料及涂饰):
Plunger: Be, Cu, Rh plated
Barrel: Brass, Gold plated
Spring: Stainless steel
- Current rating(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50mΩ(毫欧姆)

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SF-R111



Probe specifications SF-R111(技术规格)

- Recommended minimum center(最小间距): 1.90mm(.0748")
- Mounting hole size(钻孔尺寸): 压力: 1.35mm(.0532")
电木板、玻璃纤维板: 1.40mm(.0551")
- Materials and finishes(材料及涂饰):
Barrel: Brass, Gold plated
- Connections(接线形式):
Crimp: R111-VCR2.5, R111-CR
Solder cup: R111-VSC2.5, R111-SC
Wire wrap: R111-VW2.5, R111-WW2.5, R111-WW
Terminal: R111-VW(T)

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Producción Fluir



1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection

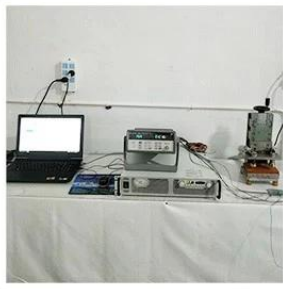


5. Finished products

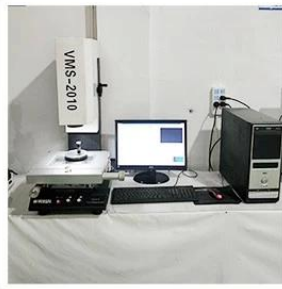


6. Packing

Prueba Equipo



1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope

Embalaje y envío

Standard products will be delivered out within 3 days. Customized products will be sent out within 15 days.

